RENESAS

3.3V CMOS 32-BIT BUS TRANSCEIVER WITH 3-STATE OUTPUTS, 5 VOLT TOLERANT I/O, BUS-HOLD

IDT74LVCH32245A

FEATURES:

- **Typical $t_{SK(o)}$ (Output Skew) < 250ps**
- **ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)**
- **V_{CC} = 3.3V ± 0.3V, Normal Range**
- **V_{CC} = 2.7V to 3.6V, Extended Range**
- **CMOS power levels (0.4μ W typ. static)**
- **All inputs, outputs, and I/O are 5V tolerant**
- **Supports hot insertion**
- **Available in 96-ball LFBGA package**

DRIVE FEATURES:

- **Balanced Output Drivers: ±24mA**
- **Reduced system switching noise**

APPLICATIONS:

- **5V and 3.3V mixed voltage systems**
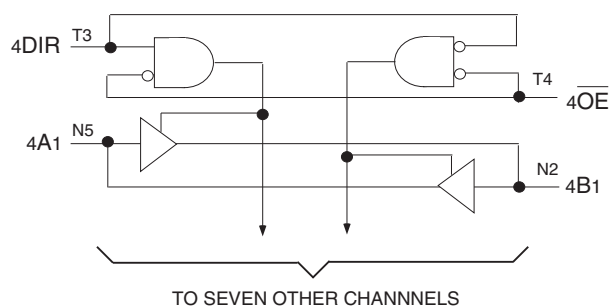- **Data communication and telecommunication systems**
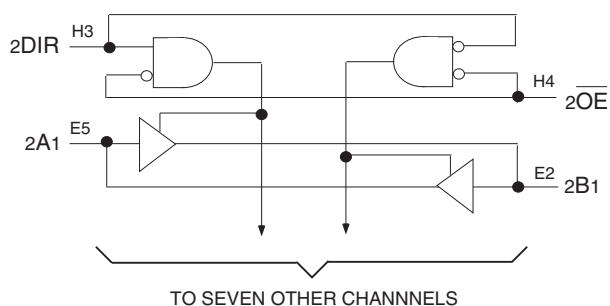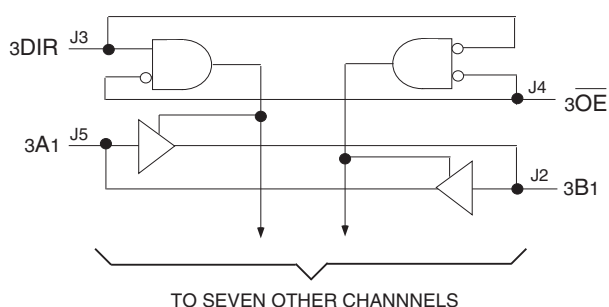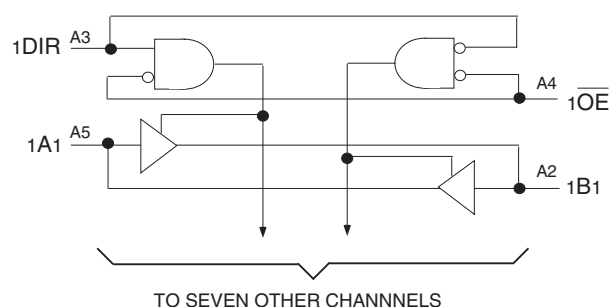
DESCRIPTION:

This 32-bit bus transceiver is built using advanced dual metal CMOS technology. This high-speed, low power transceiver is ideal for asynchronous communication between two busses (A and B). The Direction and Output Enable controls are designed to operate the device as either four independent 8-bit transceivers or one 32-bit transceiver. The direction control pins (DIR) control the direction of data flow. The output enable pins (OE) override the direction control and disable both ports. All inputs are designed with hysteresis for improved noise margin.

All pins can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V supply system.

The LVCH32245A has been designed with a ±24mA output driver. This driver is capable of driving a moderate to heavy load while maintaining speed performance

The LVCH32245A has "bus-hold" which retains the inputs' last state whenever the input goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistors.

FUNCTIONAL BLOCK DIAGRAM

TO SEVEN OTHER CHANNNELS

TO SEVEN OTHER CHANNNELS

TO SEVEN OTHER CHANNNELS

TO SEVEN OTHER CHANNNELS

INDUSTRIAL TEMPERATURE RANGE

FEBRUARY 2016

DSC-4767/5

PIN CONFIGURATION

	A	B	C	D	E	F	G	H	J	K	L	M	N	P	R	T
6	1A2	1A4	1A6	1A8	2A2	2A4	2A6	2A7	3A2	3A4	3A6	3A8	4A2	4A4	4A6	4A7
5	1A1	1A3	1A5	1A7	2A1	2A3	2A5	2A8	3A1	3A3	3A5	3A7	4A1	4A3	4A5	4A8
4	1$\overline{OE}$	GND	VCC	GND	GND	VCC	GND	2$\overline{OE}$	3$\overline{OE}$	GND	VCC	GND	GND	VCC	GND	4$\overline{OE}$
3	1DIR	GND	VCC	GND	GND	VCC	GND	2DIR	3DIR	GND	VCC	GND	GND	VCC	GND	4DIR
2	1B1	1B3	1B5	1B7	2B1	2B3	2B5	2B8	3B1	3B3	3B5	3B7	4B1	4B3	4B5	4B8
1	1B2	1B4	1B6	1B8	2B2	2B4	2B6	2B7	3B2	3B4	3B6	3B8	4B2	4B4	4B6	4B7

LFBGA
TOPVIEW

96 BALL LFBGA PACKAGE ATTRIBUTES

1.5 mm Max.
1.4 mm Nom.
1.3 mm Min.

0.8mm

TOP VIEW

5.5mm

13.5mm
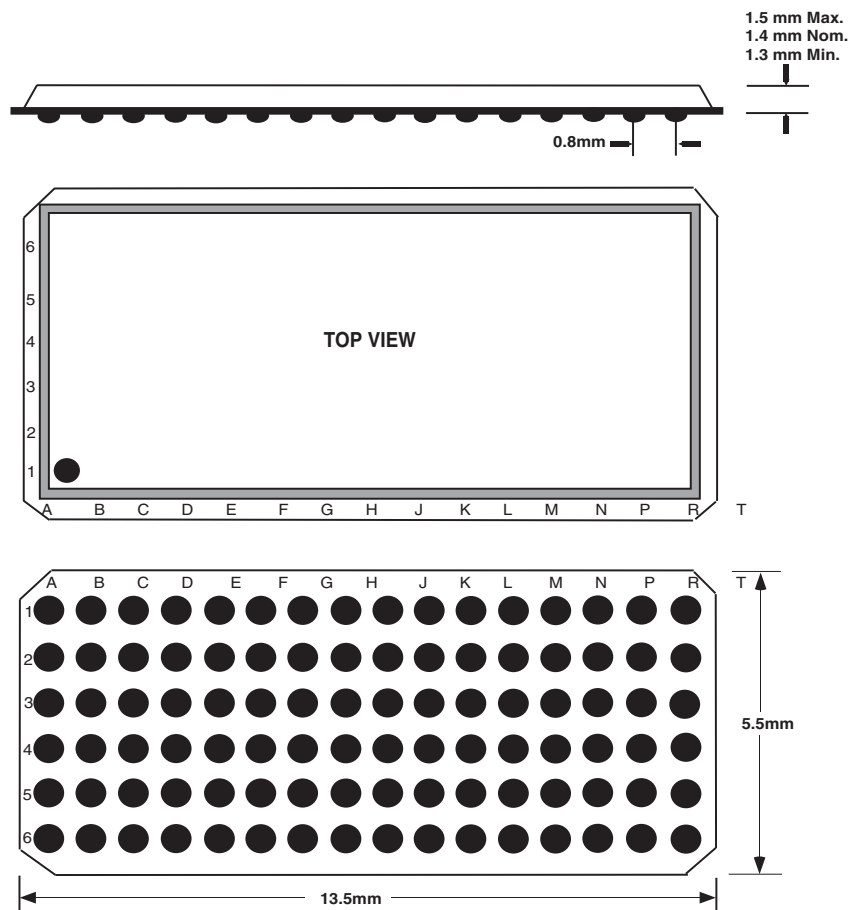
ABSOLUTE MAXIMUM RATINGS[1]

Symbol	Description	Max	Unit
V_{TERM}	Terminal Voltage with Respect to GND	–0.5 to +6.5	V
T_{STG}	Storage Temperature	–65 to +150	°C
I_{OUT}	DC Output Current	–50 to +50	mA
I_{IK} I_{OK}	Continuous Clamp Current, $V_I < 0$ or $V_O < 0$	–50	mA
I_{CC} I_{SS}	Continuous Current through each V_{CC} or GND	±100	mA

NOTE:
1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

CAPACITANCE (T_A = +25°C, F = 1.0MHz)

Symbol	Parameter[1]	Conditions	Typ.	Max.	Unit
C_{IN}	Input Capacitance	$V_{IN} = 0V$	4.5	6	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 0V$	6.5	8	pF
$C_{I/O}$	I/O Port Capacitance	$V_{IN} = 0V$	6.5	8	pF

NOTE:
1. As applicable to the device type.

PIN DESCRIPTION

Pin Names	Description
$x\overline{OE}$	Output Enable Input (Active LOW)
xDIR	Direction Control Input
xAx	Side A Inputs or 3-State Outputs[1]
xBx	Side B Inputs or 3-State Outputs[1]

NOTE:
1. These pins have "Bus-Hold". All other pins are standard inputs, outputs, or I/Os.

FUNCTION TABLE[1]

Inputs		Outputs
$x\overline{OE}$	xDIR	
L	L	Bus B data to Bus A
L	H	Bus A data to Bus B
H	X	Z

NOTE:
1. H = HIGH Voltage Level
   L = LOW Voltage Level
   X = Don't Care
   Z = High Impedance

BUS-HOLD CHARACTERISTICS

Symbol	Parameter[1]	Test Conditions		Min.	Typ.[2]	Max.	Unit
I_{BHH}	Bus-Hold Input Sustain Current	$V_{CC} = 3V$	$V_I = 2V$	–75	—	—	µA
I_{BHL}			$V_I = 0.8V$	75	—	—	
I_{BHH}	Bus-Hold Input Sustain Current	$V_{CC} = 2.3V$	$V_I = 1.7V$	—	—	—	µA
I_{BHL}			$V_I = 0.7V$	—	—	—	
I_{BHHO} I_{BHLO}	Bus-Hold Input Overdrive Current	$V_{CC} = 3.6V$	$V_I = 0$ to $3.6V$	—	—	±500	µA

NOTES:
1. Pins with Bus-Hold are identified in the pin description.
2. Typical values are at V_{CC} = 3.3V, +25°C ambient.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:
Operating Condition: T_A = –40°C to +85°C

Symbol	Parameter	Test Conditions		Min.	Typ.[1]	Max.	Unit
V_{IH}	Input HIGH Voltage Level	V_{CC} = 2.3V to 2.7V		1.7	—	—	V
		V_{CC} = 2.7V to 3.6V		2	—	—	
V_{IL}	Input LOW Voltage Level	V_{CC} = 2.3V to 2.7V		—	—	0.7	V
		V_{CC} = 2.7V to 3.6V		—	—	0.8	
I_{IH} I_{IL}	Input Leakage Current	V_{CC} = 3.6V	V_I = 0 to 5.5V	—	—	±5	µA
I_{OZH} I_{OZL}	High Impedance Output Current (3-State Output pins)	V_{CC} = 3.6V	V_O = 0 to 5.5V	—	—	±10	µA
I_{OFF}	Input/Output Power Off Leakage	V_{CC} = 0V, V_{IN} or $V_O \le$ 5.5V		—	—	±50	µA
V_{IK}	Clamp Diode Voltage	V_{CC} = 2.3V, I_{IN} = –18mA		—	–0.7	–1.2	V
V_H	Input Hysteresis	V_{CC} = 3.3V		—	100	—	mV
I_{CCL} I_{CCH} I_{CCZ}	Quiescent Power Supply Current	V_{CC} = 3.6V	V_{IN} = GND or V_{CC}	—	—	10	µA
			$3.6 \le V_{IN} \le 5.5V$[2]	—	—	10	
ΔI_{CC}	Quiescent Power Supply Current Variation	One input at V_{CC} - 0.6V, other inputs at V_{CC} or GND		—	—	500	µA

NOTES:
1. Typical values are at V_{CC} = 3.3V, +25°C ambient.
2. This applies in the disabled state only.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions[1]		Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	V_{CC} = 2.3V to 3.6V	I_{OH} = – 0.1mA	V_{CC} – 0.2	—	V
		V_{CC} = 2.3V	I_{OH} = – 6mA	2	—	
		V_{CC} = 2.3V	I_{OH} = – 12mA	1.7	—	
		V_{CC} = 2.7V		2.2	—	
		V_{CC} = 3V		2.4	—	
		V_{CC} = 3V	I_{OH} = – 24mA	2.2	—	
V_{OL}	Output LOW Voltage	V_{CC} = 2.3V to 3.6V	I_{OL} = 0.1mA	—	0.2	V
		V_{CC} = 2.3V	I_{OL} = 6mA	—	0.4	
			I_{OL} = 12mA	—	0.7	
		V_{CC} = 2.7V	I_{OL} = 12mA	—	0.4	
		V_{CC} = 3V	I_{OL} = 24mA	—	0.55	

NOTE:
1. V_{IH} and V_{IL} must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate V_{CC} range. T_A = – 40°C to + 85°C.

OPERATING CHARACTERISTICS, V_CC = 3.3V ± 0.3V, T_A = 25°C

Symbol	Parameter	Test Conditions	Typical	Unit
C_PD	Power Dissipation Capacitance per Transceiver Outputs enabled	C_L = 0pF, f = 10Mhz	76	pF
C_PD	Power Dissipation Capacitance per Transceiver Outputs disabled		8	

SWITCHING CHARACTERISTICS[1]

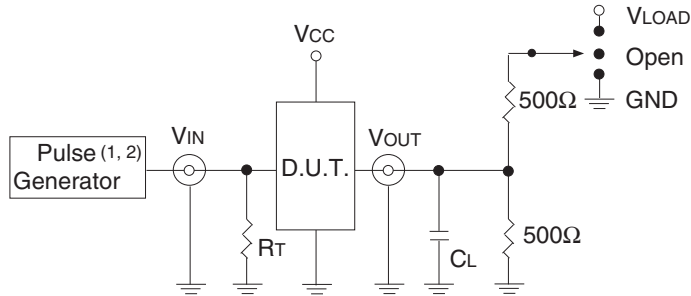| Symbol	Parameter	V_CC = 2.7V		V_CC = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	
t_PLH	Propagation Delay	1.5	4.7	1	4	ns
t_PHL	xAx to xBx, xBx to xAx					
t_PZH	Output Enable Time	1.5	6.7	1.5	5.5	ns
t_PZL	x$\overline{OE}$ to xAx or xBx					
t_PHZ	Output Disable Time	1.5	7.1	1.5	6.6	ns
t_PLZ	x$\overline{OE}$ to xAx or xBx					
t_PZH	Output Enable Time	1.5	7	1.5	5.5	ns
t_PZL	xDIR to xAx or xBx					
t_PHZ	Output Disable Time	1.5	7.4	1.5	6.6	ns
t_PLZ	xDIR to xAx or xBx					
t_SK(o)	Output Skew[2]	—	—	—	500	ps

NOTES:
1. See TEST CIRCUITS AND WAVEFORMS. T_A = – 40°C to + 85°C.
2. Skew between any two outputs of the same package and switching in the same direction.

TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	Vcc[(1)] = 3.3V ± 0.3V	Vcc[(1)] = 2.7V	Vcc[(2)] = 2.5V ± 0.2V	Unit
V_{LOAD}	6	6	2 x Vcc	V
V_{IH}	2.7	2.7	Vcc	V
V_T	1.5	1.5	Vcc / 2	V
V_{LZ}	300	300	150	mV
V_{HZ}	300	300	150	mV
C_L	50	50	30	pF

Test Circuit for All Outputs

DEFINITIONS:
C_L = Load capacitance: includes jig and probe capacitance.
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:
1. Pulse Generator for All Pulses: Rate ≤ 1.0MHz; t_F ≤ 2.5ns; t_R ≤ 2.5ns.
2. Pulse Generator for All Pulses: Rate ≤ 1.0MHz; t_F ≤ 2ns; t_R ≤ 2ns.

SWITCH POSITION

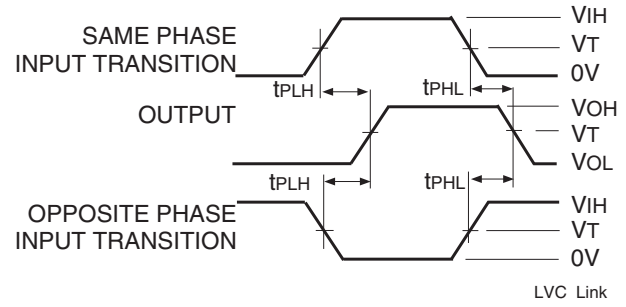| Test	Switch
Open Drain Disable Low Enable Low	V_{LOAD}
Disable High Enable High	GND
All Other Tests	Open
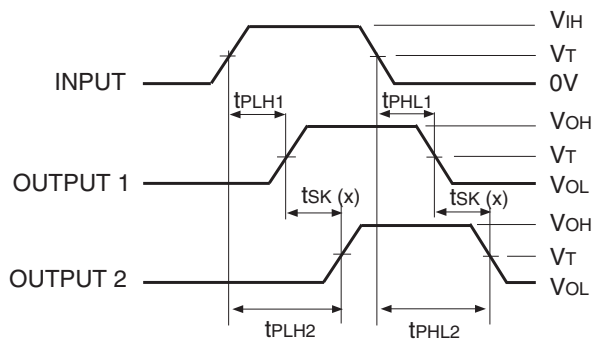
$$t_{SK}(x) = |\, t_{PLH2} - t_{PLH1} \,|\ \text{or}\ t_{PHL2} - t_{PHL1}$$
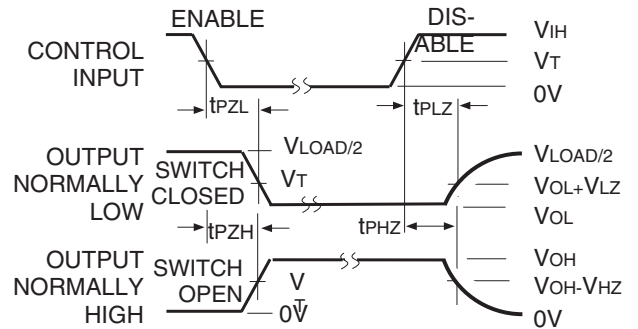
Output Skew - $t_{SK}(x)$

NOTES:
1. For $t_{SK}(o)$ OUTPUT1 and OUTPUT2 are any two outputs.
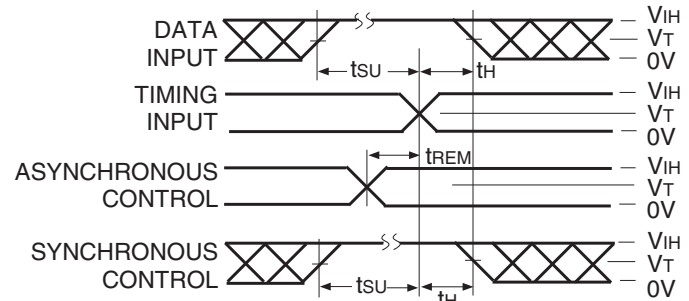2. For $t_{SK}(b)$ OUTPUT1 and OUTPUT2 are in the same bank.
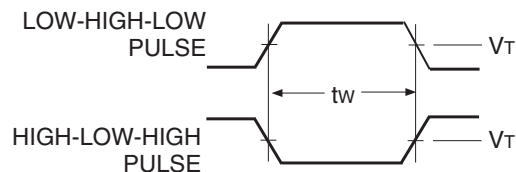

Propagation Delay

Enable and Disable Times

NOTE:
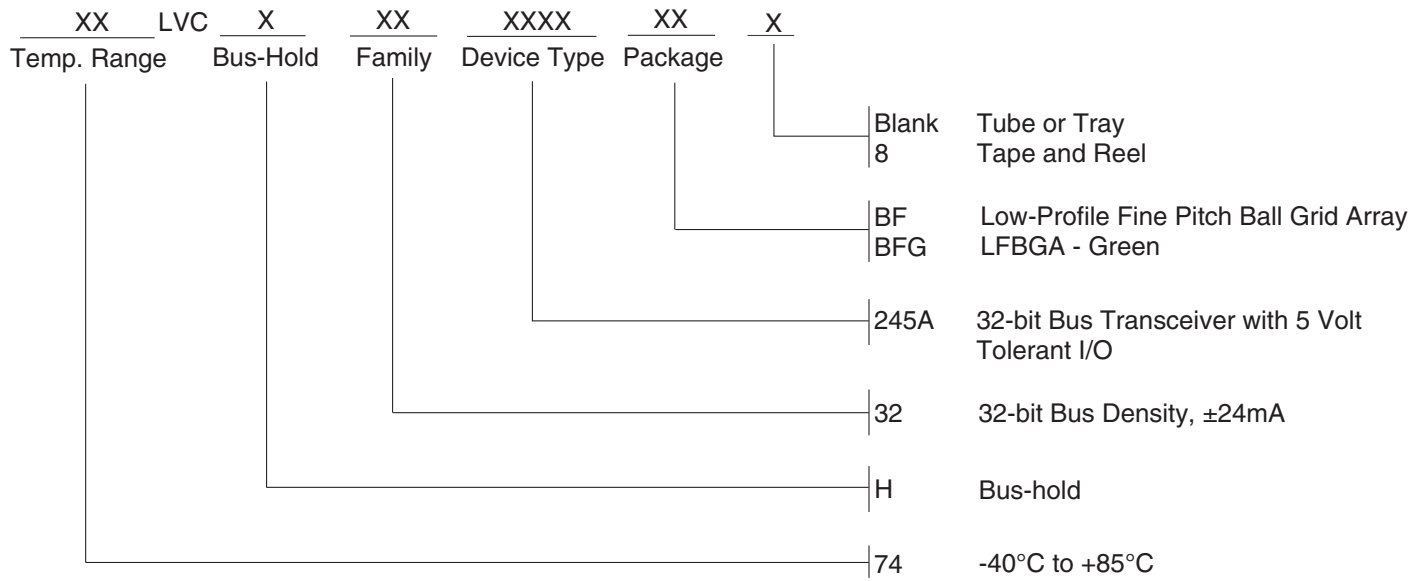1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Set-up, Hold, and Release Times

Pulse Width

ORDERING INFORMATION

XX	LVC	X	XX	XXXX	XX	X
Temp. Range		Bus-Hold	Family	Device Type	Package	

Blank	Tube or Tray
8	Tape and Reel
BF	Low-Profile Fine Pitch Ball Grid Array
BFG	LFBGA - Green
245A	32-bit Bus Transceiver with 5 Volt Tolerant I/O
32	32-bit Bus Density, ±24mA
H	Bus-hold
74	-40°C to +85°C

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(Rev.4.0-1 November 2017)

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